

Vishay Siliconix

AUTOMOTIVE

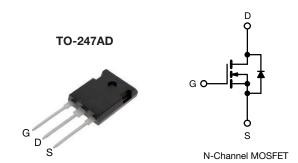
RoHS

COMPLIANT

HALOGEN FREE

Automotive E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V	0.045		
Q _g typ. (nC)	229			
Q _{gs} (nC)	53			
Q _{gd} (nC)	91			
Configuration	Single			



FEATURES

 Fast body diode MOSFET using Automotive Grade E series technology



• Low figure-of-merit (FOM) Ron x Qa

Low input capacitance (C_{iss})

• Low switching losses due to reduced Q_{rr}

• 175 °C operating temperature

- AEC-Q101 qualified
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



- · Automotive onboard charger
- Automotive DC/DC converter

ORDERING INFORMATION			
Package	TO-247AD		
Lead (Pb)-Free and Halogen-Free	SQW61N65EF-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	650	V	
Gate-Source Voltage			V_{GS}	± 30		
Continuous Drain Current (T _J = 175 °C)		V _{GS} at 10 V	T _C = 25 °C	- I _D	62	А
			$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		44	
Pulsed Drain Current ^a			I _{DM}	187		
Linear Derating Factor				4.2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	1323	mJ	
Maximum Power Dissipation				P_{D}	625	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C	
Drain-Source Voltage Slope			dV/dt	70	\//	
Reverse Diode dV/dt ^d				50	V/ns	
Soldering Recommendations (Peak temperature	re) ^c	For	10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 73.5 mH, R_g = 25 Ω , I_{AS} = 6 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 470 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	LIMIT	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	40	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	0.24	G/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	650	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	-	0.77	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	2.0	-	4.0	V	
0.1. 0		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V			± 1	μΑ
Zava Cata Valtaga Drain Current		V _{DS} = 520 V, V _{GS} = 0 V		-	-	1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 520 V	V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C		-	500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 32 A	-	0.045	0.052	Ω
Forward Transconductance	g _{fs}	V _{DS} = 30 V, I _D = 32 A		-	28	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 1 MHz		-	7379	-	pF
Output Capacitance	Coss			-	310	-	
Reverse Transfer Capacitance	C _{rss}			-	4	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	213	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	841	-	
Total Gate Charge	Qg			-	229	344	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 32 \text{ A}, V_{DS} = 520 \text{ V}$		-	53	-	nC
Gate-Drain Charge	Q _{gd}				91	-	
Turn-On Delay Time	t _{d(on)}			-	65	98	
Rise Time	t _r	$V_{DD} = 520 \text{ V}, I_{D} = 32 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	107	161	ns
Turn-Off Delay Time	t _{d(off)}			-	252	378	
Fall Time	t _f			-	102	153	
Gate Input Resistance	R_g	f = 1 MHz, open drain		0.5	1	2	Ω
Drain-Source Body Diode Characteristics	S						
Continuous Source-Drain Diode Current	Is	MOSFET sym	MOSFET symbol		-	62	
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	187	Α
Diode Forward Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 32 \text{A}, V_{GS} = 0 \text{V}$		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}				204	408	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}$, $I_F = I_S = 30.5 \text{A}$, $di/dt = 100 \text{A/}\mu\text{s}$, $V_R = 400 \text{V}$		-	1.9	3.8	μC
Reverse Recovery Current	I _{RRM}			-	18	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

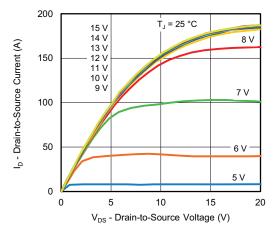


Fig. 1 - Typical Output Characteristics

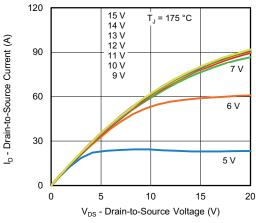


Fig. 2 - Typical Output Characteristics

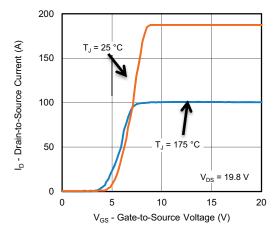


Fig. 3 - Typical Transfer Characteristics

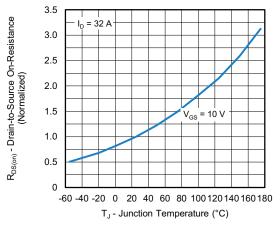


Fig. 4 - Normalized On-Resistance vs. Temperature

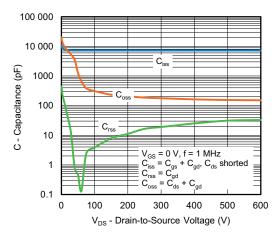


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

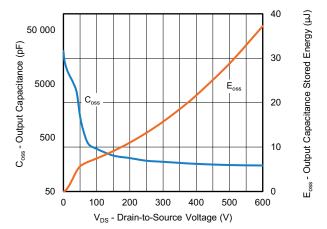


Fig. 6 - Coss and Eoss vs. VDS



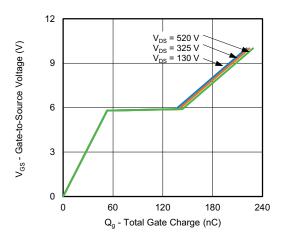


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

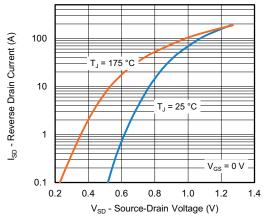


Fig. 8 - Typical Source-Drain Diode Forward Voltage

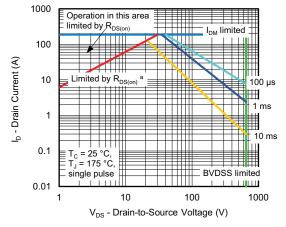


Fig. 9 - Maximum Safe Operating Area



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

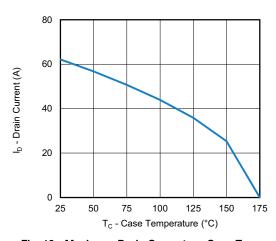


Fig. 10 - Maximum Drain Current vs. Case Temperature

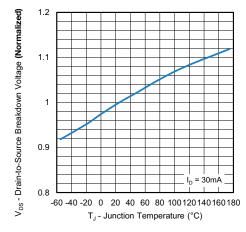


Fig. 11 - Temperature vs. Drain-to-Source Voltage



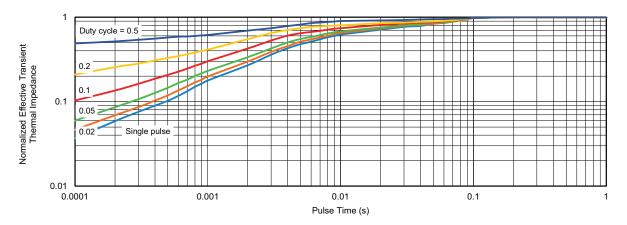


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

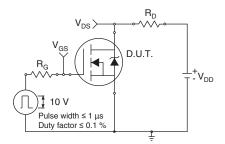


Fig. 13 - Switching Time Test Circuit

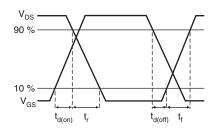


Fig. 14 - Switching Time Waveforms

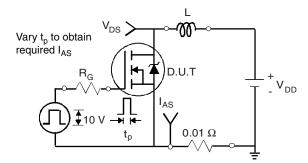


Fig. 15 - Unclamped Inductive Test Circuit

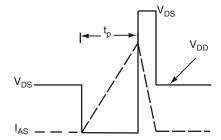


Fig. 16 - Unclamped Inductive Waveforms

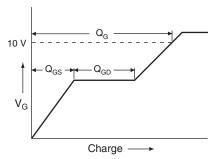


Fig. 17 - Basic Gate Charge Waveform

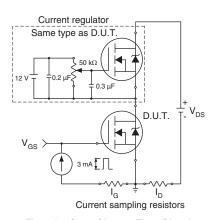
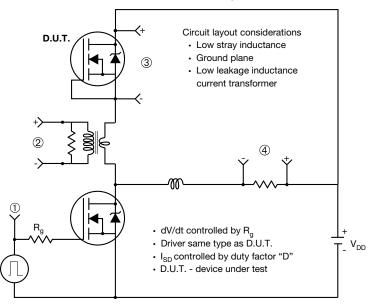


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



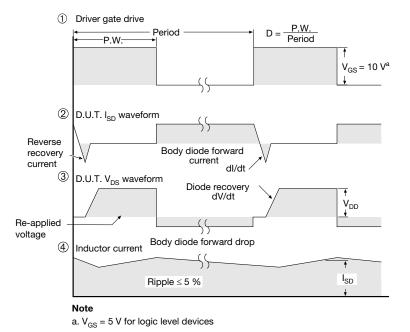


Fig. 19 - For N-Channel

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